

## 1. 模块概述:

HPTZ01X (HPTZ01-TTL, HPTZ01P-TTL的统称, 下同)系列ZigBee 透传模块是我司采用Ember ZigBee EM35x芯片开发的一款低成本, 高性能, 基于IEEE 802.15.4-2003标准的2.4GHZ ISM频段的ZigBee网络协议的无线串口透明传输通信模块。模块支持点对点、Mesh网络多种灵活弹性组网方式。实现极易使用、全透明、高稳定、超低功耗、超远距离、超大规模ZigBee无线传感网络的组网, 实现客户的各种组网运用。

HPTZ01X 透传模块广泛运用于物联网行业, 如: 灯光控制系统、家居自动化、智能楼宇控制、无线抄表系统、无线传感器网络、安防系统、无线应用。

产品特点:

- ◆ 低功耗设计, 支持多级休眠和唤醒, 最大限度降低功耗
- ◆ 简单的TTL电平UART接口, 支持多种波特率可设置, 适应各种不同档次的MCU
- ◆ 支持ZigBee无限短距离数据传输功能
- ◆ 两种设备 Coordinator和End Device, Coordinator建网之后可当Route使用, 用户可随意切换, End Device采用低功耗设计, 支持多种休眠时间设置, 低功耗静态电流<1uA
- ◆ 支持点对点, 点对多点, 星型, 树形, Mesh网络拓扑结构, 可以多达65000节点
- ◆ 工作在2.4G ISM波段, 支持11-26通道, 只需简单的UART命令, 模块自动从11-26通道中选择干净的信道建立网络
- ◆ 模块若掉电, 网络可自动修复, 在上电时, 可以恢复到先前的稳定网络中
- ◆ 高安全性, 通过Link Key可构建独立的PAN网络, 别的网络无法加入, 以防数据泄露, 阻止非授权节点连接到网络
- ◆ 使用方便, 用户不需要了解复杂的ZigBee 协议栈, 只需调用几条简单的UART命令, 就可创建安全、可靠、高效、的无线网络
- ◆ 带RSSI功能, 预示的链路质量的好坏, 供运用层做参考、处理
- ◆ 高接收灵敏度, 超小封装, 方便嵌入到任何的设备当中

## 2. 产品系列:

产品系列有以下几种, 按天线接口, 功率大小分为以下几种

Table2-1 HPTZ01X的具体型号(下单型号见本规格书最后部分)

型号	功能类型	接口类型	天线形式	尺寸
HPTZ01-TTL-A	协调器、路由器	SMD	自带SMD陶瓷天线 IPEX标准接口 不带标准射频连接器, 直接50 OHM输出	21X15X3.3mm
HPTZ01-TTL-B	睡眠设备			
HPTZ01P-TTL-A	协调器、路由器	SMD	自带SMD陶瓷天线 IPEX标准接口 不带标准射频连接器, 直接50 OHM输出	25X15X3.3mm
HPTZ01P-TTL-B	睡眠设备			

### 3. HPTZ01X PIN 脚位标注图:

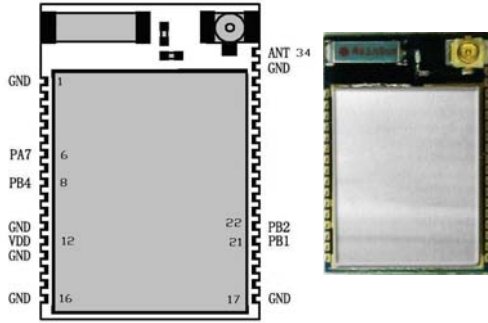


Figure3.1 HPTZ01-TTL

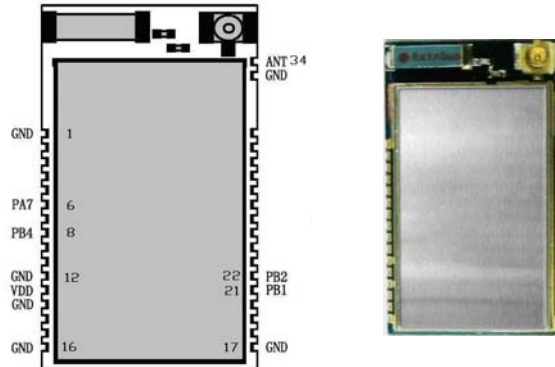


Figure3.2 HPTZ01P-TTL

管脚定义: HPTZ01X Table3-1

管脚编号	名称	方向	管脚说明	类型说明
1, 11, 13, 16, 17, 33	GND	地	电源负极	全部类型
6	PA7	输出	输出上升沿唤醒信号, 唤醒HOT MCU	全部类型
8	PB4	输入	输入上升沿唤醒信号, 唤醒HPTZ01X	仅睡眠设备
12	VDD	电源	电源正极	全部类型
21	PB1	输出	HPTZ01X串口Tx	全部类型
22	PB2	输入	HPTZ01X串口Rx	全部类型

### 4. 应用参考接线图

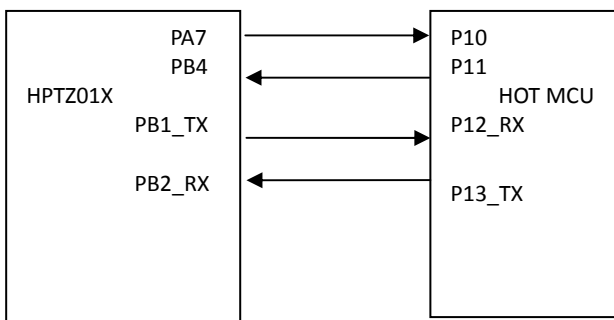


Figure4.1 睡眠设备与 HOT MCU 的连接图

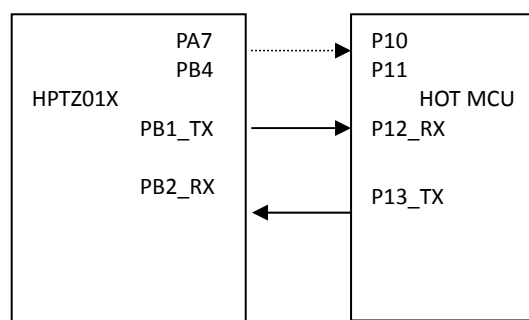


Figure4.2 协调器或路由与 HOT MCU 的连接图

## 5. Electrical Characteristics

### 5.1 Absolute Maximum Ratings

Table 5-1: Absolute Maximum Ratings

Parameter	Test Conditions	Min.	Max.	Unit
Regulator input voltage (VDD)		-0.3	+3.6	V
RF Input Power (for max level for correct packet reception)			+15	dBm
Voltage on any GPIO PA7, PB4, PB2, PB1		-0.3	VDD +0.3	V
Storage temperature		-40	+140	°C

### 5.2 Recommended Operating Conditions

Table 5-2: Operating Conditions

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Regulator input voltage (VDD)		2.1		3.6	V
Operating temperature range(notel)		-20		+70	°C

notel: -40°C to +85°C operational

### 5.3 Electrical Specifications

Table 5-3: Electrical Specifications

(VCC = 3.0V, Fo =2440MHZ, T=25°C, if nothing else stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Operating frequency		2400		2500	MHZ
Supply voltage		2.1		3.6	V
Numbers of channels	For IEEE 802.15.4 compliance	-	16	-	
Channel spacing	For IEEE 802.15.4 compliance	-	5	-	MHz
Maximum output power	HPTZ01-TTL	-21	-	+3	dBm
	HPTZ01P-TLL	-	+20	-	dBm
Sensitivity	HPTZ01-TTL PER = 1% PER, 20byte packet		-102		dBm
	HPTZ01-TTL PER = 1% PER, 20byte packet		-100		dBm
	HPTZ01P-TTL PER = 1% PER, 20byte packet		-110		dBm
	HPTZ01-TTL +3dBm transmission power		29		mA
	HPTZ01P-TTL 20dBm transmission power		170		mA
	HPTZ01-TTL		27		mA
	HPTZ01P-TTL		38		mA
On-Air Data Rate			250		Kbps
Deep sleep current	END-Device	-	0.7	3	uA
Frequency stability				+/-40	ppm
RF Input/output impedance	IPEX connector output Unbalanced output		50		Ohm

## 5.4 Application Specifications

table5-4

用户数据区长度最大		80 bytes			
网络类型		点对点，网状网结构			
TTL UART接口形式及波特率		8bit, 1bit stop bit, 1bit start bit, no parity bit. Baud rate 300~460800bps, default is 9600bps			
	序列号 SEQ NUM	命令 CMD ID	长度 LEN	数据包 DATA	校验码 VALID CODE
2 Bytes	1 Byte	1 Byte	1 Byte	N Bytes	1 Byte
0x6A, 0x95	每次通讯递增	见“命令及应答清单”，bit7为1时是应答	数据包的长度	见《通信协议》的详细定义，每个定义子项目中低字节在前，高字节在后	前面所有字节的单字节加法

Table5-5 命令及应答清单（另外开发资料《通信协议》详解各CMD用法）

CMD_HELLO	0x00
CMD_HELLO_RSP	0x80
CMD_RESET	0x01
CMD_SET_BAUD	0x02
CMD_SET_BAUD_RSP	0x82
CMD_SET_POWER	0x03
CMD_SET_POWER_RSP	0x83
CMD_SET_HEARTBEAT	0x04
CMD_SET_HEARTBEAT_RSP	0x84
CMD_GET_VDD	0x05
CMD_GET_VDD_RSP	0x85
CMD_BUILD_NETWORK	0x06
CMD_BUILD_NETWORK_RSP	0x86
CMD_PERMIT_JOINING	0x07
CMD_PERMIT_JOINING_RSP	0x87
CMD_SCAN_NETWORK	0x08
CMD_SCAN_NETWORK_RSP	0x88
CMD_JOIN_NETWORK	0x09
CMD_JOIN_NETWORK_RSP	0x89
CMD_AUTOJOIN_NETWORK	0x0A
CMD_AUTOJOIN_NETWORK_RSP	0x8A
CMD_LEAVE_NETWORK	0x0B
CMD_LEAVE_NETWORK_RSP	0x8B
CMD_DELETE_DEVICE	0x0C
CMD_DELETE_DEVICE_RSP	0x8C
CMD_GET_INFO	0x0D
CMD_GET_INFO_RSP	0x8D
CMD_GET_KEY	0x0E
CMD_GET_KEY_RSP	0x8E
CMD_SEND_DATA	0x0F
CMD_SEND_DATA_RSP	0x8F
CMD_RECEIVED_DATA	0x10
ACK	0xFF

6. 自组网方式：

HPTZ01X ZigBee数传模块支持点对点、Mesh 网络自动组网方式，实现完全的数据透明传输，满足不同客户的不同应用需求。在一个Zigbee网络有且仅有一个中心节点协调器(Coordinator)，其通常和PC或其它USB主机通过USB连接；其余节点都可以为路由节点(Router)，或者睡眠设备(End\_Device)，End\_Device设备主要适用于采用电池供电的场合，路由节点既可以采集数据也可以转发与路由其它节点的数据，起到增加通讯距离的作用，扩大整个网络的覆盖范围。

下面给出两种组网方式的示意图



Figure6.1 P2P拓扑结构

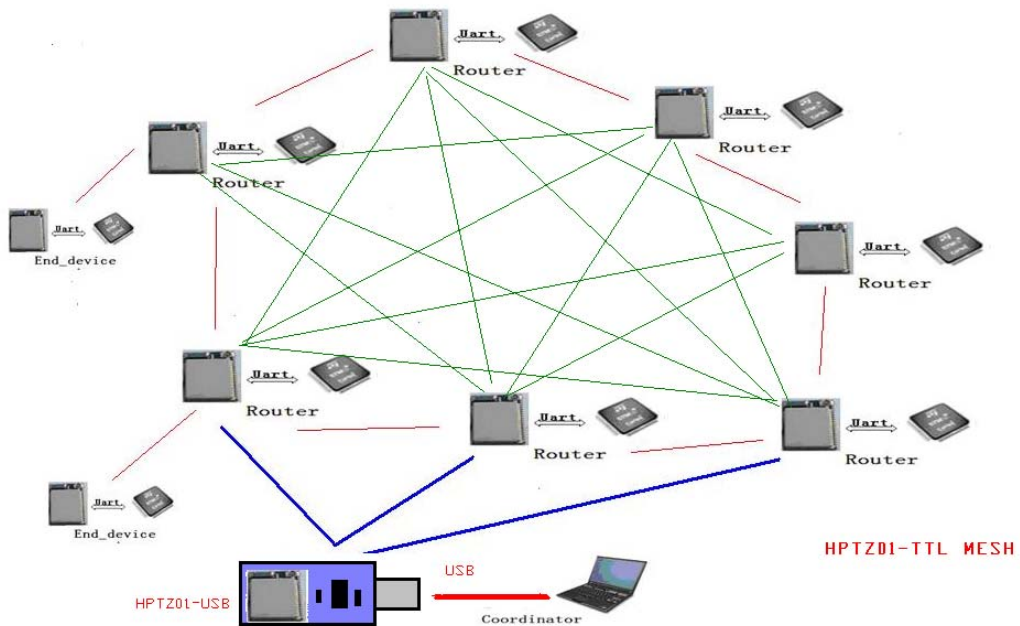


Figure6.2 网状网结构

## 7 Mechanical Dimensions

All dimensions in MM

Figure 7.1: HPTZ01-TTL Mechanical Dimensions

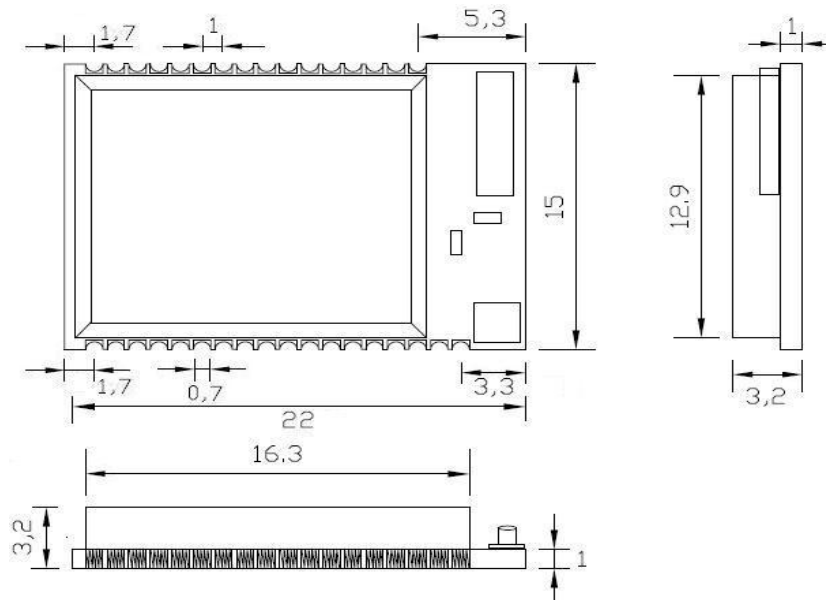
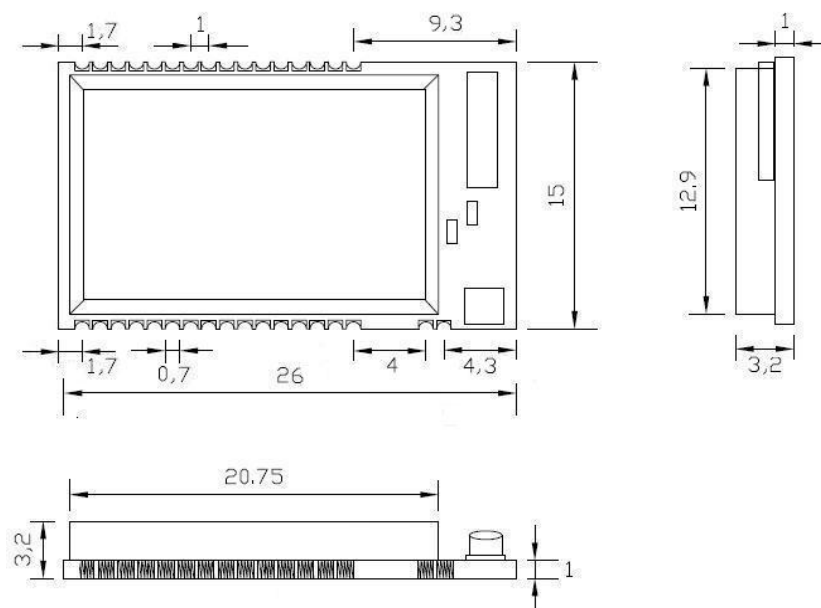


Figure 7.2: HPTZ01P-TTL Mechanical Dimensions



## 8 Mounting Information

The below diagrams show the PCB footprint recommended for the modules.  
All dimensions in MM

Figure8.1:  
HPTZ01(P)-ANT and HPTZ01(P)X-IPEX module Recommended PCB footprint ,Top View

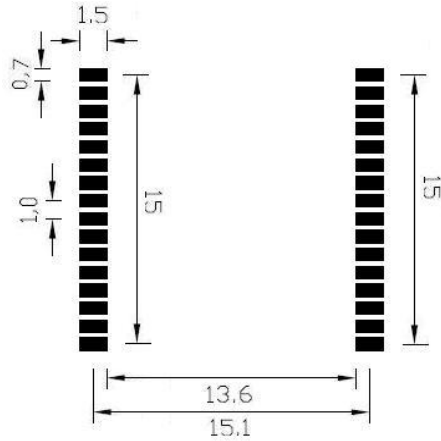


Figure8.2: HPTZ01X-U0 module Recommended PCB footprint, Top View

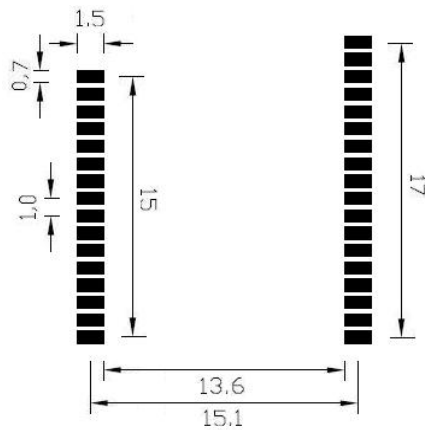
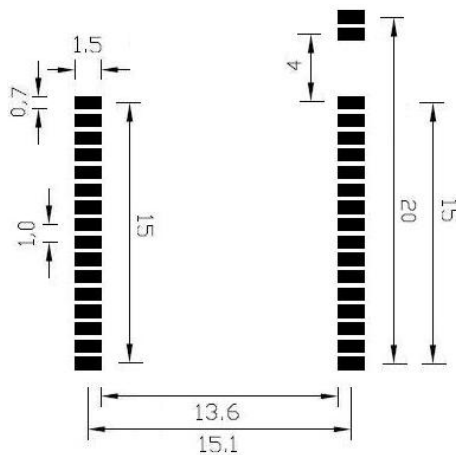


Figure8.3: HPTZ01P-U0 module Recommended PCB footprint, Top View



## 9 Soldering Profile

Table9-1: Soldering Profile

Profile Feature	Green Package
Average ramp-up rate(217°C to peak)	3°C/s max
Preheat temperature 175°C +/-25°C	180s max
Temperature maintained above 217°C	60S to 150S
Time within 5°C of actual peak temperature	20s to 40s
Peak temperature rang	260°C
Ramp-down rate	6°C/s max
Time within 25°C to peak temperature	8 minutes max

## 10 Ordering Information

Table10-1: Ordering Information

Part Number	Description
HPTZ01-TTL-A-ANT	Coordinator or Router, +3dBm output power, -102dBm sensitivity, With built-in SMD antenna.
HPTZ01-TTL-B-ANT	End device, +3dBm output power, -102dBm sensitivity, With built-in SMD antenna.
HPTZ01P-TTL-A-ANT	Coordinator or Router, +20dBm output power, -110dBm sensitivity, With built-in SMD antenna
HPTZ01P-TTL-B-ANT	End device, +20dBm output power, -110dBm sensitivity, With built-in SMD antenna
HPTZ01-TTL-A-IPEX	Coordinator or Router, +3dBm output power, -102dBm sensitivity, With Built-in IPEX connector for external antenna
HPTZ01-TTL-B-IPEX	End Device, +3dBm output power, -102dBm sensitivity, With Built-in IPEX connector for external antenna
HPTZ01P-TTL-A-IPEX	Coordinator or Router, +20dBm output power, -110dBm sensitivity, With Built-in IPEX connector for external antenna
HPTZ01P-TTL-B-IPEX	End Device, +20dBm output power, -110dBm sensitivity, With Built-in IPEX connector for external antenna
HPTZ01-TTL-A-U0	Coordinator or Router, +8dBm output power, -102dBm sensitivity, With unbalanced RF output for external antenna
HPTZ01-TTL-B-U0	End Device, +8dBm output power, -102dBm sensitivity, With unbalanced RF output for external antenna
HPTZ01P-TTL-A-U0	Coordinator or Router, +20dBm output power, -110dBm sensitivity, With unbalanced RF output for external antenna
HPTZ01P-TTL-B-U0	End Device, +20dBm output power, -110dBm sensitivity, With unbalanced RF output for external antenna



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